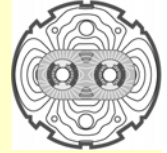


Issues Raised by the Design of the LHC Beam Dump Entrance Window

Ray Veness / CERN

With thanks to B.Goddard and A.Presland



Introduction

o Window vs. Absorber

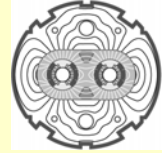
- o This talk is about a window, not a collimator, so the objective is to pass the beam rather than intercept it

o However,

- o Design requires a good knowledge of the interaction between the beam and materials
- o Requirements for materials are very similar (low CTE, low Z, good high temperature strength)
- o Test and analysis requirements may yield some 'symbiosis'

o Aim of talk

- o Explain the LHC dump entrance window design, stressing similarities and differences to collimators and absorbers
- o Discuss some open issues, which may (hopefully) have already been addressed in collimator or absorber design

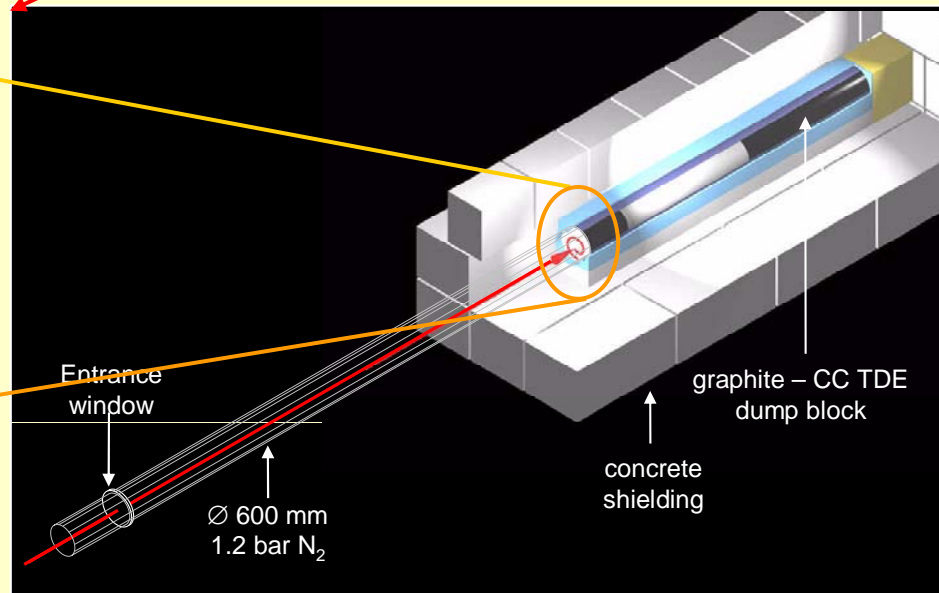
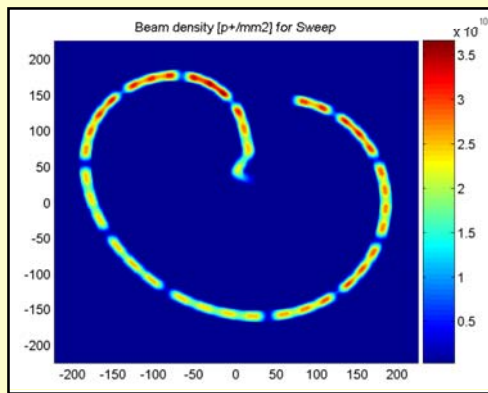
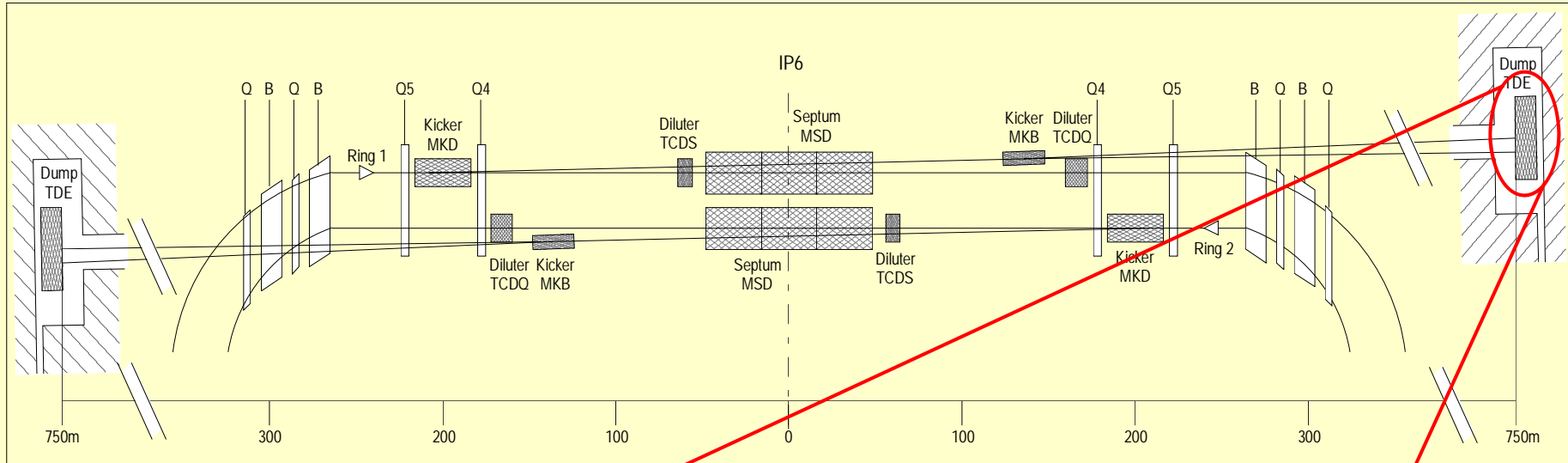
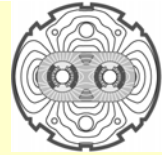


Contents

- o **Beam dump entrance window design**
 - o Overview
 - o Concept
 - o Analysis
- o **Issues**
 - o Energy in the system
 - o Properties of carbon-carbon composite
- o **Final remarks**

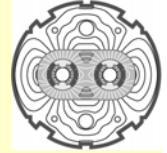


Overview of beam dump system



Courtesy of B.Goddard
WS on Materials for
Collimators and Absorbers

issues- R.Veness



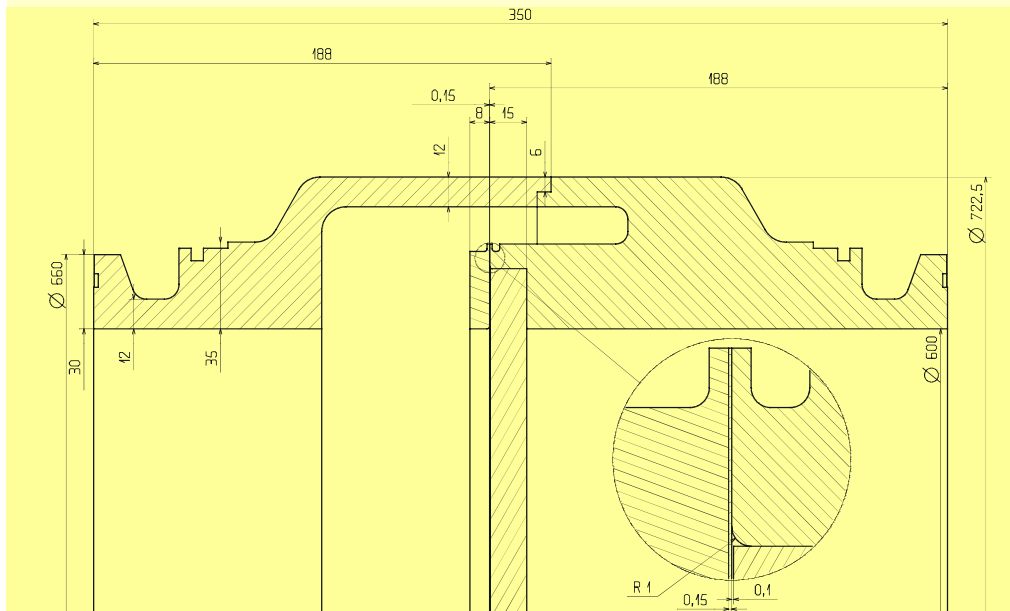
Window functionality

- o Separate graphite dump core (TDE) from the dump line (TD) and LHC vacuum
 - o TDE kept at 1.2 - 1.4 bar N₂ pressure
 - o TD line kept at 10⁻⁷ mbar pressure
 - o Must withstand 1.4 bar static pressure load
 - o Must withstand repeated (2-4 per day) normal dump beam load for LHC lifetime
 - o 600 mm clear beam aperture
 - o Must not fail catastrophically for worst case beam dump dilution failure (ie, can leak, but not collapse)

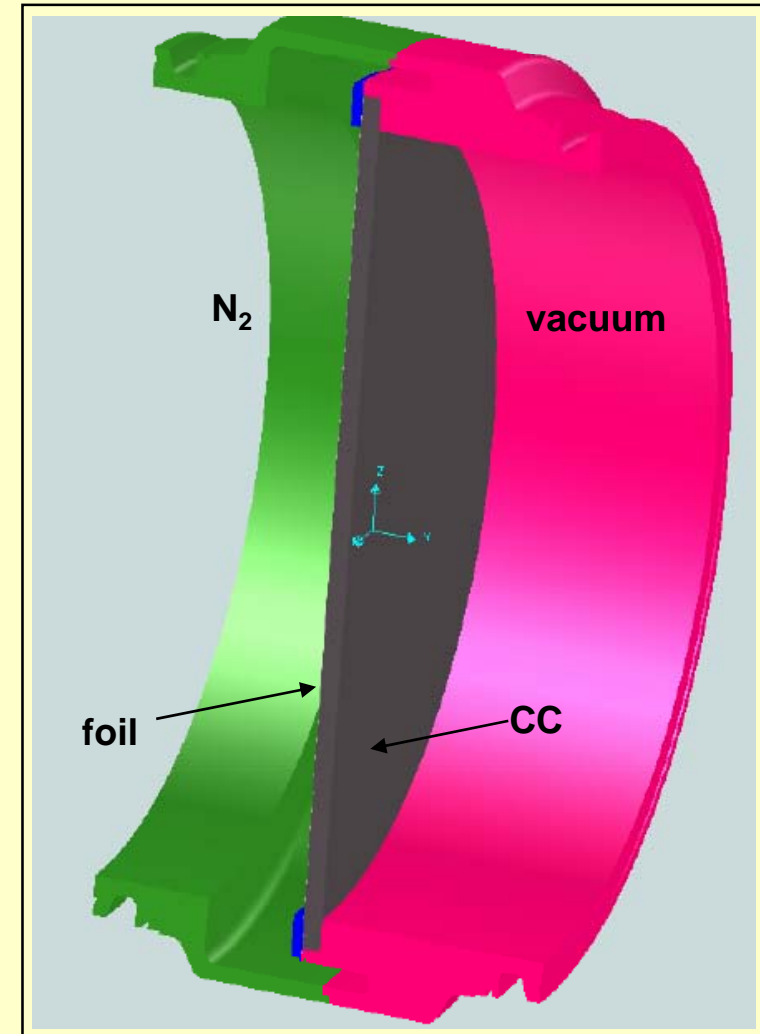
Entrance Window Concept

o Separate Vacuum and Mechanical requirements

- o 15mm thick C-C sheet for structure
- o Thin metal foil for leak tightness
- o Foil supported by, but free to move over the C-C



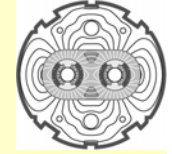
WS on Materials for Collimators and Absorbers



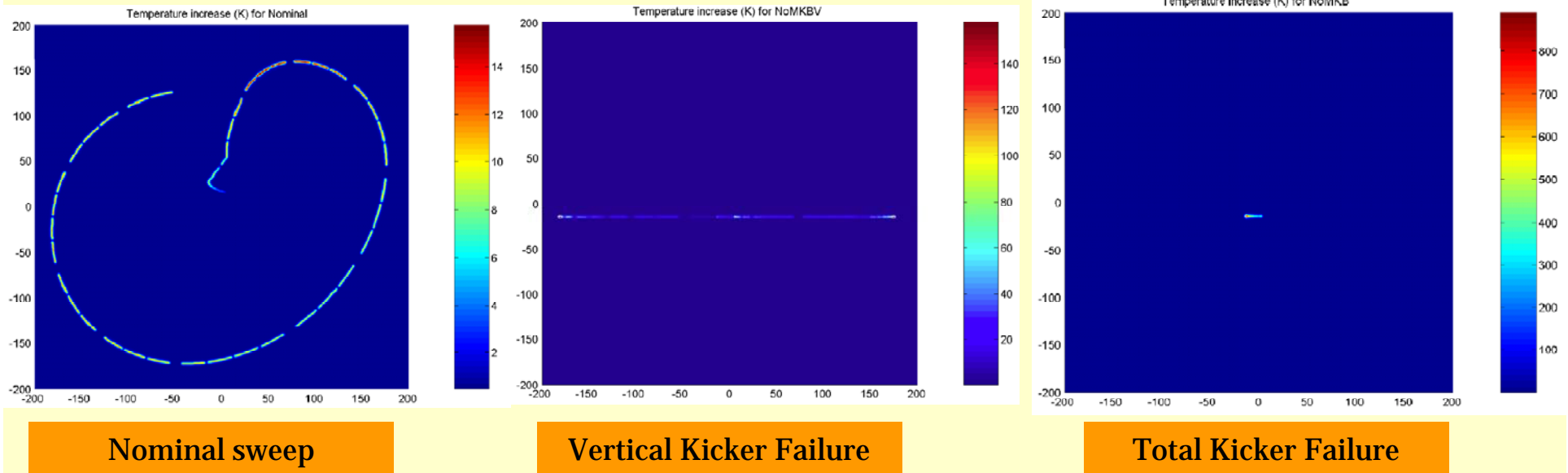
Dump Window Issues- R.Veness



Window Design - FLUKA

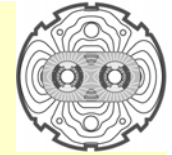


Temperature maps on the C-C window for nominal beam sweep and kicker failure scenario cases

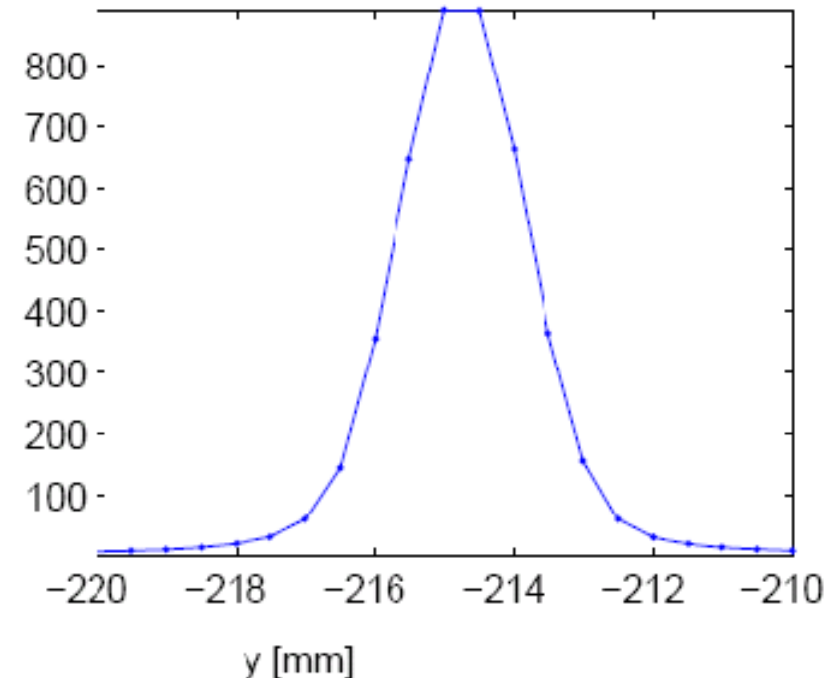




Window Design - Mechanics



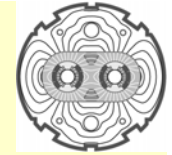
- o Main design issues (as with collimators)
 - o Very rapid temperature rise, with high peak value
 - o Localised temperature step
- o Axisymmetric thin window allows some simplifications
 - o Thin plate - can plane stress analysis for initial analysis
 - o Relatively small variation of through-thickness temperature - can neglect in some analyses
- o Static mechanical loads
 - o Pressure loads can be calculated analytically and superposed



Detail of transverse temperature profile for total kicker failure case in C-C plate



Design – Thermo-elastic analysis



o Analysis

- o Used bulk properties of C-C
 - o Combination of low transverse CTE and low E give moderate stresses
- o Static FE analysis, with temperature profiles from FLUKA
 - o Compares well with 'ideal temperature step' stress, $E\alpha\Delta T$
- o Estimated the effect of dynamic stress based on semi-analytical solution for a thin disc from Sievers [1]
 - o Compares heating time with time taken for stress wave to pass the heated zone
 - o Only a small (few %) dynamic stress contribution predicted by this method
 - o Therefore decided not to proceed to full finite element dynamic analysis
- o Did not consider out-of-plane modes

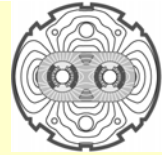
Load case	C-C ΔT (K)	C-C Stress (MPa)
One bunch	1	0.2
Nominal	15	1
No MBKH	116	5
No MBKV	166	9
No MBK	891	57

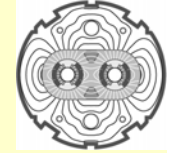
Summary of FLUKA (temperature) and ANSYS (von Mises stress) results for the different load cases

Is this justified??



Window installed in dump line





Issues – Energy Deposition

o Some numbers

- o 362 MJ passes through window per nominal beam dumped
- o 662 J absorbed in window (from FLUKA) - 0.00018%
- o 662 J is equivalent to a 10g bullet travelling at 360 ms⁻¹

o The effect of this absorbed energy

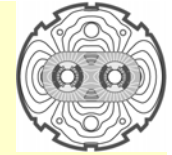
- o Steady-state temperature rise in the window of 0.12°C
- o The C-C sees 37 times less thermo-elastic stress than stainless steel for the same temperature profile

o Concerns

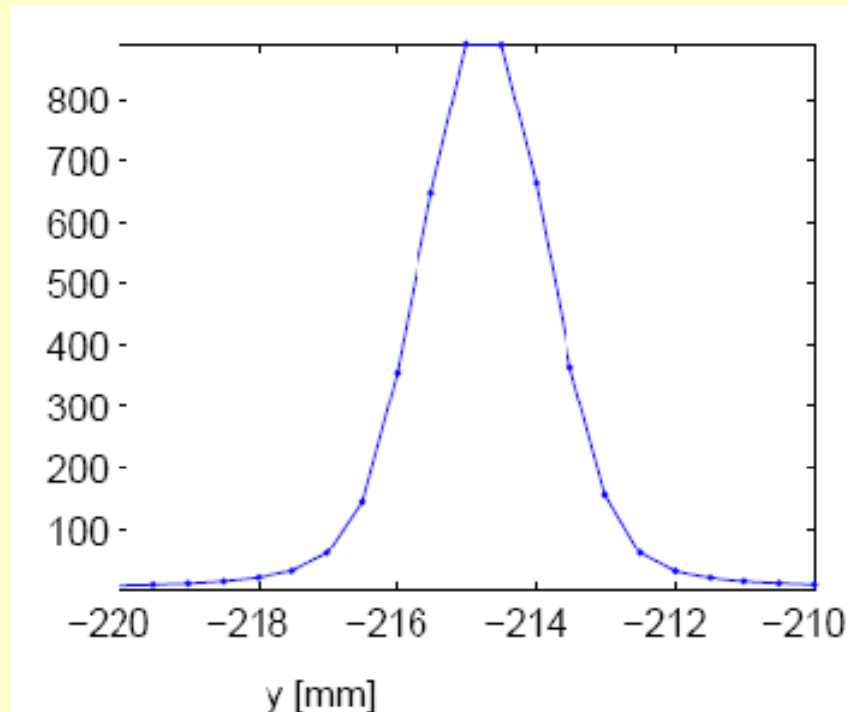
- o A vast amount of energy passes through the window
 - o Consequences of calculation errors are great
- o Only a minute fraction is absorbed by the window, due to the very low Z of the C-C material
 - o Reliant on FLUKA output
- o This energy causes very little stress, due to the very low CTE of the C-C material
 - o Reliant on material properties



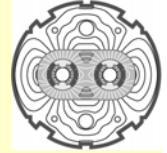
Issue – C-C properties



- Window design uses a composite material that is relatively poorly qualified in an extreme environment (for the total failure case)
 - Transverse ΔT of up to $500^\circ\text{C}/\text{mm}$ in C-C during total kicker failure case
 - Considering a fibre diameter of $15\mu\text{m}$ and a volume fraction 0.5, this gives a worst-case ΔT of 15°C between individual fibres
- Are bulk material properties valid?
 - What is the shear stress due to differential thermal expansion between fibre and matrix
 - Is significant damage at the fibre-matrix level possible?



Detail of temperature profile for total kicker failure case in C-C plate



Final Remarks

o Entrance window design

- o There are many similarities to collimator designs, but the analysis is made simpler by the axi-symmetric, thin plate geometry
- o The energy passing through the window is very high - it is important that the assumptions are correct
- o The design is robust for nominal conditions, but the failure scenarios raise questions about the use of bulk material properties for the composite

o Future work

- o The dynamic stress analysis should be re-visited
 - o Out of plane vibrations
 - o What is the best code to use?
- o Diagnostic methods for monitoring the state of the window, eg the acoustic method presented yesterday?
- o A window is potentially a good method for testing materials and qualifying codes
 - o The 2-D geometry is simpler to model - verification of FE results?
 - o It may be possible to insert windows 'parasitically' in fixed target lines or dump lines